

Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

| Supplier Nexperia B.V. | | User Part Number | | | | | | |
|---|-----------------------------|---|-------------|-----------|------------|-----------|--|--|
| | | PDTC144TU | | | | | | |
| Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test | | Part Description | | | | | | |
| | | Nexperia DHAM Small Signal Bipolar Transistor | | | | | | |
| | | SMD package | | | | | | |
| | | Test Conditions | Duration | # Lots | # Quantity | # Rejects | | |
| | TEST | | | | | | | |
| | Pre- and Post-Stress | | | | | | | |
| # E1 | Electrical Test | Tamb = 25 °C | N/A | see below | all parts | see below | | |
| | | JESD22-A113 | | | | | | |
| | | Bake Tamb = 125 °C | 24 hours | | | | | |
| | PC | Soak Tamb = 85 °C, RH = 85% | 168 hours | | | _ | | |
| # A1 | Preconditioning | Reflow soldering | 3 cycles | 849 | 61170 | 0 | | |
| | | MIL-STD-750-1 | | | | | | |
| | HTRB | M1039 Method A | | | | | | |
| | | Tj = Tjmax, Vr = 100% of max. datasheet | | | | _ | | |
| # B1 | Bias | reverse voltage | 1000 hours | 202 | 16160 | 0 | | |
| | | JECD22 A104 | | | | | | |
| | TC Temperature Cycling | JESD22-A104 -65 °C to Tjmax, not to exceed 150°C | 1000 | 171 | 12600 | 0 | | |
| # A4 | remperature Cycling | • ' | 1000 cycles | 171 | 13680 | 0 | | |
| | AC | JESD22-A102 Tamb = 121 °C, RH = 100 % | | | | | | |
| # A3 alt | AC Autoclave | Pressure = 205 kPa (29.7 psia) | 96 hours | 170 | 12040 | 0 | | |
| F A3 alt | Autociave | Fressure = 203 KFa (23.7 psia) | 96 nours | 173 | 13840 | 0 | | |
| | H3TRB | JESD22-A101 | | | | | | |
| | High Humidity High | Tamb = 85 °C, RH = 85%, VR = 80 % of | | | | | | |
| # A2 alt | | rated reverse voltage ^[1] | 1000 hours | 173 | 13840 | 0 | | |
| AZ dil | Temperature Reverse Blas | | 1000 110015 | 1/3 | 13040 | U | | |
| | IOL | MIL-STD-750 Method 1037 ton = toff, devices powered to insure ΔT_i = | | | | | | |
| # A5 | Intermittent Operating Life | | 1000 hours | 197 | 15760 | 0 | | |
| + A3 | Intermittent Operating Life | 100 C 101 15000 Cycles | TOOO HOURS | 19/ | 13/00 | U | | |
| | RSH | JESD22-A111 | | | | | | |
| # C8 | Resistance to Solder Heat | 260 °C ± 5 °C | 10 s | 135 | 4050 | 0 | | |
| . 00 | SD | 200 0 = 0 0 | 10.2 | 133 | 4030 | U | | |
| # C10 | Solderability | 1-STD-002 | | 342 | 3420 | 0 | | |
| r C10 | 20.acrability | 3 3.5 332 | | J4Z | J42U | U | | |

^[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1)
Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Wafer Fab | Technology | Quantity | Rejects | Failure Rate (FIT) | MTTF (hrs) |
|-----------|----------------------|----------|---------|--------------------|------------|
| Nexperia | Small Signal Bipolar | | | | |
| DHAM | Transistor | 16160 | 0 | 0.26 | 3.81E+09 |

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